

AN11044

Pin FMEA for 74HC/74HCT family

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Application note

Document information

| Information | Content |
|-------------|--|
| Keywords | FMEA, HC, HCT, CMOS |
| Abstract | This application note provides a Failure Modes and Effects Analysis (FMEA) for Nexperia's 74HC/74HCT family under typical failure situations |

1. Introduction

The 74HC/74HCT high-speed Si-gate CMOS logic family combines the low power advantages of the HEF4000B family with the high speed and drive capability of the Low power Schottky TTL (LSTTL).

The 74HC/74HCT family has the same pin-out as the 74 series and provides the same circuit functions. The family includes several HEF4000B family circuits that do not have TTL counterparts, and have some special circuits. The basic family of buffered devices, designated as 74HCxxxx, operates at CMOS input logic levels for high-noise immunity with negligible typical quiescent supply and input current. The family requires a power supply of 2 V to 6 V. A subset of the family, designated as 74HCTxxxx with the same features as the "HC-types" will operate with a standard TTL power supply of 5 V ($\pm 10\%$) and logic input levels (0.8 V to 2.0 V) for use as pin-to-pin compatible CMOS replacements for reducing power consumption without loss of speed. These types are also suitable for TTL-to-CMOS switching converters.

2. Pin FMEA

This application note provides a Failure Modes and Effects Analysis (FMEA) for the device pins of Nexperia's HC/HCT family under typical failure situations such as a short-circuit to V_{CC} or GND or to a neighboring pin, or if a pin is left open.

A failure is classified according to its effect on the HC/HCT device and the functionality of the application; see [Table 1](#).

Table 1. Classification of failure effects

| Class | Failure effect |
|-------|--|
| A | damage to device |
| | affects application functionality |
| B | no damage to device |
| | may affect application functionality |
| C | no damage to device |
| | no affect to application functionality |

Table 2. FMEA matrix for pin short-circuit to V_{CC}

| Pin | Class | Remarks |
|-------------|-------|--|
| Input | B | normal operating condition, no damage, no leakage, may affect functionality |
| Output | C | if output defined HIGH, no damage, no leakage, no output level change |
| Output | A | if output defined LOW, short-circuits and high currents can damage device, output level changes |
| GND | B | short-circuits and high currents can damage device, will affect functionality |
| Exposed pad | A | Short-circuits and high currents can damage device and will affect the functionality. It only applies in case exposed pad has GND potential by internal connection. See data sheet of product concerned. |

Table 3. FMEA matrix for pin short-circuit to GND

| Pin | Class | Remarks |
|-----------------|-------|--|
| Input | B | normal operating condition, no damage, no leakage, may affect functionality |
| Output | C | if output defined LOW, no damage, no leakage, no output level change |
| Output | A | if output defined HIGH, short-circuits and high currents can damage device, output level changes |
| V _{CC} | B | if input defined LOW, no damage, affects functionality |
| V _{CC} | A | if input defined HIGH, short-circuits and high currents can damage device, affects functionality |
| Exposed pad | A | Short-circuits and high currents can damage device and will affect the functionality. It only applies in case exposed pad has V _{CC} potential by internal connection. See data sheet of product concerned. |

Table 4. FMEA matrix for pin left open

| Pin | Class | Remarks |
|-----------------|-------|---|
| Input | B | undefined operating condition, no damage, increases leakage, may affect functionality |
| Output | C | normal operating condition, no damage, no leakage |
| GND | B | undefined operating condition, no damage, increases leakage, will affect functionality |
| V _{CC} | B | if input defined LOW, undefined operating condition, no damage, increases leakage (only for I/O types), affects functionality |
| V _{CC} | B | if input defined HIGH, device is powered via input circuit, may affect functionality |

Table 5. FMEA matrix for pin short-circuits between neighbor pins

| Pin | Class | Remarks |
|---------------------------|-------|--|
| Input to input | C | if inputs have same voltage levels: no damage, no leakage |
| | B | if inputs have different voltage levels: leakage increases, will affect functionality |
| Input to output | A | if input and output have different voltage levels, can cause high current and can damage device, will affect functionality |
| | C | if input and output have same voltage levels, no damage, no leakage |
| Input to GND | - | see Table 3 |
| Input to V _{CC} | - | see Table 2 |
| Output to output | C | if outputs have same voltage levels, no damage, no leakage |
| | A | if outputs have different voltage levels, can cause high current and can damage device, will affect functionality |
| Output to input | - | same effect as 'input to output' condition |
| Output to GND | - | see Table 3 |
| Output to V _{CC} | - | see Table 2 |
| GND to V _{CC} | - | not applicable, these pins are not neighbors |

3. Abbreviations

Table 6. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal-Oxide Semiconductor |
| FMEA | Failure Modes and Effects Analysis |
| LSTTL | Low power Schottky TTL |
| TTL | Transistor-Transistor Logic |

4. Revision history

Table 7. Revision history

| Rev | Date | Description |
|-----|----------|--|
| v.2 | 20190109 | AN11044, updated to latest Nexperia documentation standard |
| v.1 | 20110316 | AN11044 initial version |

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